CQD-4M CQD-4N

SURFACE MOUNT SILICON TRIACS 4.0 AMP, 600 THRU 800 VOLT



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DESCRIPTION:

The CENTRAL SEMICONDUCTOR CQD-4M and CQD-4N are epoxy molded silicon TRIACs designed for full wave AC control applications featuring gate triggering in all four quadrants.

MARKING: FULL PART NUMBER



MAXIMUM RATINGS: (T_C=25°C unless otherwise noted)

SYMBOL CQD-4M CQD-4N UNITS

SYMBOL	CQD-4M	CQD-4N	UNITS
V_{DRM}	600	800	V
I _T (RMS)	4	.0	Α
ITSM	4	0	Α
I ² t	2	.4	A^2s
P_{GM}	3	.0	W
P _G (AV)	0	.2	W
I _{GM}	1	.2	Α
T_J	-40 to	+125	°C
T _{stg}	-40 to	+150	°C
	VDRM IT(RMS) ITSM I ² t PGM PG(AV) IGM TJ	VDRM 600 IT(RMS) 4 ITSM 4 I ² t 2 PGM 3 PG(AV) 0 IGM 1 T _J -40 to	VDRM 600 800 IT(RMS) 4.0 ITSM 40 I ² t 2.4 PGM 3.0 PG(AV) 0.2 IGM 1.2 T _J -40 to +125

ELECTRICAL CHARACTERISTICS: (T_C=25°C unless otherwise noted)

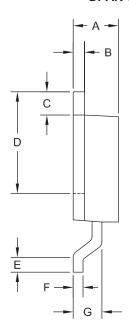
SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
IDRM	Rated V_{DRM} , R_{GK} =1 $K\Omega$			10	μΑ
I _{DRM}	Rated V_{DRM} , R_{GK} =1K Ω , T_{C} =125°C			200	μΑ
I_{GT}	V _D =12V, QUAD I, II, III		2.5	5.0	mA
I_{GT}	V _D =12V, QUAD IV		5.4	9.0	mA
lΗ	R _{GK} =1KΩ		1.6	5.0	mA
V_{GT}	V _D =12V, QUAD I, II, III, IV		0.95	1.75	V
V_{TM}	I _{TM} =6.0A, tp=380μs		1.25	1.75	V
dv/dt	V _D =2/ ₃ V _{DRM,} T _C =125°C	11			V/µs

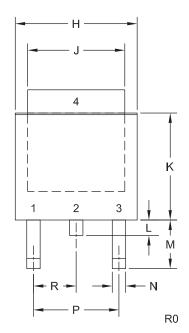
CQD-4M CQD-4N

SURFACE MOUNT SILICON **TRIACS** 4.0 AMP, 600 THRU 800 VOLT



DPAK CASE - MECHANICAL OUTLINE





LEAD CODE:

- 1) MT1
- 2) MT2
- 3) Gate 4) MT2

MARKING: FULL PART NUMBER

DIMENSIONS								
	INCHES		MILLIMETERS					
SYMBOL	MIN	MAX	MIN	MAX				
Α	0.083	0.108	2.10	2.75				
В	0.016	0.032	0.40	0.81				
С	0.035	0.063	0.89	1.60				
D	0.203	0.228	5.15	5.79				
E	0.020	-	0.51	-				
F	0.018	0.024	0.45	0.60				
G	0.051	0.071	1.30	1.80				
Н	0.248	0.268	6.30	6.81				
J	0.197	0.217	5.00	5.50				
K	0.209	0.245	5.30	6.22				
L	0.025	0.040	0.64	1.02				
М	0.090	0.115	2.30	2.91				
N	0.012	0.045	0.30	1.14				
Р	0.180		4.	60				
R	0.090		2.	30				
DDAK (DEV) DO								

DPAK (REV: R0)

R2 (21-January 2013)

OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- Custom product and package development

REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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